- Inputs Are TTL-Voltage Compatible
- Flow-Through Architecture Optimizes PCB Layout
- Center-Pin V<sub>CC</sub> and GND Configurations Minimize High-Speed Switching Noise
- EPIC<sup>™</sup> (Enhanced-Performance Implanted CMOS) 1-μm Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic Small-Outline Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs

#### description

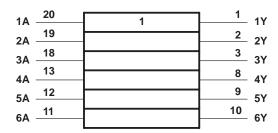
These devices contain six independent noninverters. They perform the Boolean function Y = A.

The 54ACT11034 is characterized for operation over the full military temperature range of  $-55^{\circ}$ C to 125°C. The 74ACT11034 is characterized for operation from  $-40^{\circ}$ C to  $85^{\circ}$ C.

## FUNCTION TABLE (each buffer)

INPUT A	OUTPUT Y
Н	Н
L	L

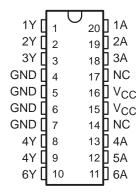
## logic symbol†



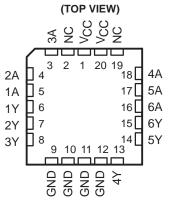
<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the DW, J, and N packages.

#### 54ACT11034 . . . J PACKAGE 74ACT11034 . . . DW OR N PACKAGE (TOP VIEW)

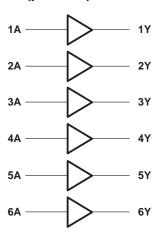


### 54ACT11034 . . . FK PACKAGE



NC - No internal connection

#### logic diagram (positive)



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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	0.5 V to 7 V
Input voltage range, V <sub>I</sub> (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Output voltage range, VO (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ )	±20 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CC</sub> )	0.00000000000000000000000000000000000
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$	0.00000000000000000000000000000000000
Continuous current through V <sub>CC</sub> or GND	± 150 mA
Storage temperature range	

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### recommended operating conditions

		54ACT11034		74ACT	LINUT	
		MIN	MAX	MIN	MAX	UNIT
VCC	Supply voltage	4.5	5.5	4.5	5.5	V
VIH	High-level input voltage	2		2		V
$V_{IL}$	Low-level input voltage		0.8		0.8	V
VI	Input voltage	0	VCC	0	Vcc	V
VO	Output voltage	0	VCC	0	Vcc	V
IOH	High-level output current		-24		-24	mA
lOL	Low-level output current		24		24	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	0	10	0	10	ns/V
T <sub>A</sub>	Operating free-air temperature	-55	125	- 40	85	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	Vaa	T <sub>A</sub> = 25°C			54ACT11034		74ACT11034		UNIT
PARAMETER		VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
VOH	I <sub>OH</sub> = - 50 μA	4.5 V	4.4			4.4		4.4		· V
		5.5 V	5.4			5.4		5.4		
	I <sub>OH</sub> = – 24 mA	4.5 V	3.94			3.7		3.8		
		5.5 V	4.94			4.7		4.8		
	$I_{OH} = -50 \text{ mA}^{\ddagger}$	5.5 V				3.85				
	$I_{OH} = -75 \text{ mA}^{\ddagger}$	5.5 V						3.85		
	Ι <sub>ΟL</sub> = 50 μΑ	4.5 V			0.1		0.1		0.1	V
		5.5 V			0.1		0.1		0.1	
\/o:	I <sub>OL</sub> = 24 mA	4.5 V			0.36		0.5		0.44	
VOL		5.5 V			0.36		0.5		0.44	
	$I_{OL} = 50 \text{ mA}^{\ddagger}$	5.5 V					1.65			
	$I_{OL} = 75 \text{ mA}^{\ddagger}$	5.5 V							1.65	
lį	$V_I = V_{CC}$ or GND	5.5 V			± 0.1		± 1		± 1	μΑ
ICC	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			4		80		40	μΑ
ΔI <sub>CC</sub> §	One input at 3.4 V, Other inputs at GND or V <sub>CC</sub>	5.5 V			0.9		1		1	mA
Ci	$V_I = V_{CC}$ or GND	5 V		3.5						pF

Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

<sup>§</sup> This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or VCC.



NOTE 1: The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

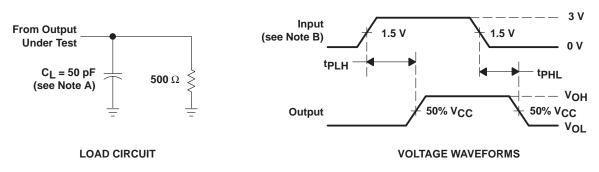
## switching characteristics over recommended ranges of supply voltage and free-air temperature (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	TO (OUTPUT)	T <sub>A</sub> = 25°C			54ACT11034		74ACT11034		UNIT
	(INPUT)		MIN	TYP	MAX	MIN	MAX	MIN	MAX	I UNII
<sup>t</sup> PLH	Anu	V	1.5	6.1	8.9	1.5	10.5	1.5	9.9	no
t <sub>PHL</sub>	Any	1	1.5	5.2	8	1.5	9.6	1.5	8.9	ns

### operating characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$

	PARAMETER TEST CONDITIONS		TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance per gate	$C_L = 50 \text{ pF}, \qquad f = 1 \text{ MHz}$	29	pF

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_f = 3 \text{ ns}$ ,  $t_f = 3 \text{ ns}$ .
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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